





APPLICABLE STANDARD							
RATING	OPERATING TEMPERATURE RANGE	-35 °C TO +85°C (NOTE1)		STORAGE TEMPERATURE RANGE	-10 °C TO +60°C (NOTE3)		
	OPERATING HUMIDITY RANGE	20% TO 80% (NOTE2)		STORAGE HUMIDITY RANGE	40% TO 70% (NOTE3)		
	APPLICABLE CONNECTOR	DF61-2S-2.2C		UL, C-UL Rating	Voltage	350 V AC/DC	
	VOLTAGE	350 V AC/DC					
	CURRENT	AWG 28 : 3.0A AWG 26 : 3.2A AWG 24 : 4.0A AWG 22 : 5.0A					
					Current	AWG 28 : 3.0A AWG 26 : 3.2A AWG 24 : 4.0A AWG 22 : 5.0A	
SPECIFICATIONS							
ITEM		TEST METHOD		REQUIREMENTS		QT	AT
CONSTRUCTION							
GENERAL EXAMINATION		VISUALLY AND BY MEASURING INSTRUMENT.		ACCORDING TO DRAWING.		X	X
MARKING		CONFIRMED VISUALLY.				X	X
ELECTRIC CHARACTERISTICS							
CONTACT RESISTANCE MILLIVOLT LEVEL METHOD		20mV MAX, 1mA (DC or 1000Hz).		10 mΩ MAX.		X	—
INSULATION RESISTANCE		500 V DC.		1000 MΩ MIN.		X	—
VOLTAGE PROOF		1700 V AC FOR 1 min.		NO FLASHOVER OR BREAKDOWN.		X	—
MECHANICAL CHARACTERISTICS							
MECHANICAL OPERATION		30 TIMES INSERTION AND EXTRACTION.		①CONTACT RESISTANCE: 20 mΩ MAX. ②NO DAMAGE, CRACK OR LOOSENESS OF PARTS.		X	—
CONTACT INSERTION AND EXTRACTION FORCES		IT TAKES OUT AND INSERTS WITH A CONFORMITY CONNECTOR.		①INSERTION FORCE : 20.0N MAX. ②EXTRACTION FORCE: 0.5N MIN.		X	—
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 10 CYCLES FOR 3 DIRECTION.		①NO ELECTRICAL DISCONTINUITY OF 1 μ s. ②NO DAMAGE, CRACK OR LOOSENESS OF PARTS.		X	—
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.				X	—
ENVIRONMENTAL CHARACTERISTICS							
DAMP HEAT (STEADY STATE)		EXPOSED AT 40 ± 2°C , 90 TO 95 %, 96 h. (AFTER LEAVING THE ROOM TEMPERATURE FOR 1~2h.)		①CONTACT RESISTANCE: 20 mΩ MAX. ②INSULATION RESISTANCE: 500 MΩ MIN. ③NO DAMAGE, CRACK OR LOOSENESS OF PARTS.		X	—
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -55°C→ +85°C TIME 30min→ 30min UNDER 5 CYCLES. (THE TRANSFERRING TIME OF THE TANK IS 2~3 min) (AFTER LEAVING THE ROOM TEMPERATURE FOR 1~2h.)		①CONTACT RESISTANCE: 20 mΩ MAX. ②INSULATION RESISTANCE: 500 MΩ MIN. ③NO DAMAGE, CRACK OR LOOSENESS OF PARTS.		X	—
RESISTANCE TO SOLDERING HEAT		1) REFLOW SOLDERING « REFLOW TIME » NUMBER OF REFLOW CYCLES : 2 CYCLES MAX. DURATION ABOVE 220 °C, 60 sec. MAX. PEAK TEMPERATURE: 250°C 10 sec. MAX. « PRE-HEAT TIME » PRE-HEAT TEMPERATURE :150~180 °C PRE-HEAT TIME : 90~120 sec. 2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE :350±10°C, SOLDERING TIME : 3sec. NO STRENGTH ON CONTACT.		NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.		X	—
SOLDERABILITY		SOLDERING TEMPERATURE : 245°C DURATION OF IMMERSION :SOLDERING, FOR 5 sec.		NEW UNIFORM COATING OF SOLDER SHALL COVER MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.		X	—
NOTE1:INCLUDE THE TEMPERATURE RISING BY CURRENT. NOTE2:NO CONDENSING. NOTE3:APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFOR MOUNTED ON PCB. AFTER MOUNTED ON PCB, OPERATION TEMPERATURE AND HUMIDITTY RANGE ARE APPLIED FOR INTERIM STRAGE DURING TRANSPORTATION.							
	COUNT	DESCRIPTION OF REVISIONS		DESIGNED		CHECKED	DATE
	1	DIS-H-00005315		SN. MIWA		SZ. ONO	20191004
REMARKS Unless otherwise specified, refer to IEC 60512.				APPROVED		KI. AKIYAMA	20120425
				CHECKED		HK. UMEHARA	20120424
				DESIGNED		TT. OHSAKO	20120424
				DRAWN		TT. OHSAKO	20120424
Note QT:Qualification Test AT:Assurance Test X:Applicable Test				DRAWING NO.		ELC-336115-23-03	
	SPECIFICATION SHEET			PART NO.		DF61-2P-2. 2V (23)	
	HIROSE ELECTRIC CO., LTD.			CODE NO.		CL666-5001-1-23	 1/1